

-60V/-30A P-Channel MOSFET**Features**

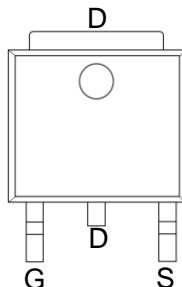
- High density cell design for ultra low $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

Product Summary

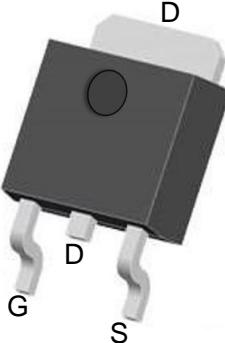
V_{DS}	$R_{DS(ON)\text{ MAX}}$	$I_D \text{ MAX}$
-60V	40m Ω @-10V	-30A
	50m Ω @-4.5V	

Application

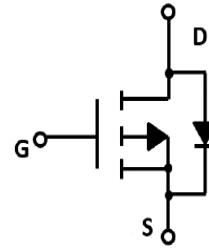
- PWM applications
- Power management
- Load switch



pin assignment



TO-252 bottom view



Schematic diagram

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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Common Ratings (TC=25°C Unless Otherwise Noted)

V_{DS}	Drain-Source Breakdown Voltage	-60	V	
V_{GS}	Gate-Source Voltage	± 20	V	
T_J	Maximum Junction Temperature	150	°C	
T_{STG}	Storage Temperature Range	-55 to 150	°C	
I_S	Diode Continuous Forward Current	Tc=25°C	-30	A

Mounted on Large Heat Sink

I_{DM}	Pulse Drain Current Tested	Tc=25°C	-135	A
I_D	Continuous Drain Current	Tc=25°C	-30	A
P_D	Maximum Power Dissipation	Tc=25°C	80	W
R_{QJA}	Thermal Resistance Junction-to-Ambient		50	°C/W

Electrical Characteristics (TJ=25°C unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
$BV_{(BR)DSS}$	Drain-Source Breakdown Voltage	$VGS=0V, ID=-250\mu A$	-60	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	$VDS=-60V, VGS=0V$	--	--	-1	uA
I_{GSS}	Gate-Body Leakage Current	$VGS=\pm 20V, VDS=0V$	--	--	± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$VDS=VGS, ID=-250\mu A$	-1.0	-1.8	-2.5	V
$R_{DS(on)}$	Drain-Source On-State Resistance	$VGS=-10V, ID=-20A$	--	30	40	mΩ
		$VGS=-4.5V, ID=-15A$	--	40	50	mΩ

Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)

C_{ISS}	Input Capacitance	VDS=-30V, VGS=0V, f=1MHz	--	2156	--	pF
C_{OSS}	Output Capacitance		--	143	--	pF
C_{RSS}	Reverse Transfer Capacitance		--	100	--	pF

Switching Characteristics

Q_g	Total Gate Charge	VDS=-30V, ID=-9A, VGS=-10V	--	40	--	nC
Q_{gs}	Gate Source Charge		--	7	--	nC
Q_{gd}	Gate Drain Charge		--	8	--	nC
$t_{d(on)}$	Turn-on Delay Time	VDD=-30V, ID=-9A, VGS=-10V, RG=3Ω	--	12	--	nS
t_r	Turn-on Rise Time		--	14	--	nS
$t_{d(off)}$	Turn-Off Delay Time		--	38	--	nS
t_f	Turn-Off Fall Time		--	15	--	nS

Source- Drain Diode Characteristics

V_{SD}	Forward on voltage	$T_j=25^\circ C, I_s=-30A,$	--	--	-1.2	V
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Typical Operating Characteristics

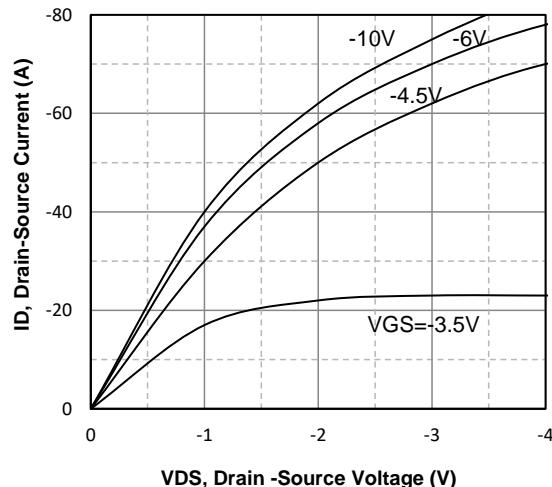


Fig1. Typical Output Characteristics

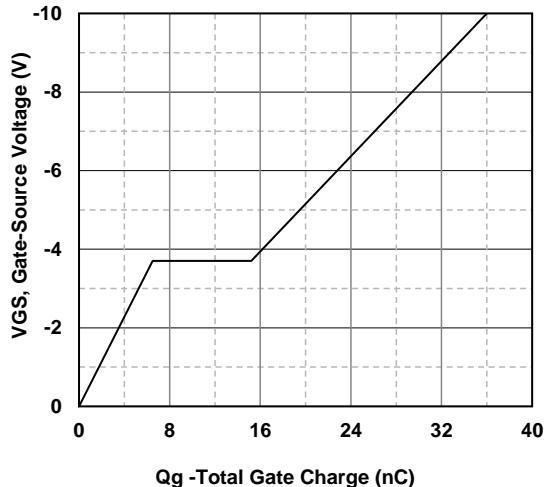


Fig2. Typical Gate Charge Vs.Gate-Source Voltage

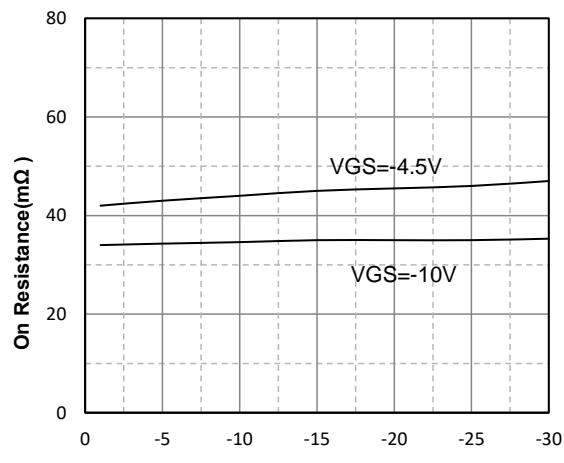


Fig3. Drain-Source on Resistance

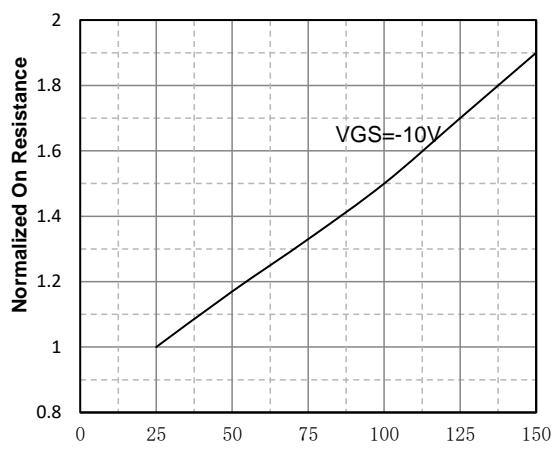


Fig4. Normalized On-Resistance Vs. Temperature

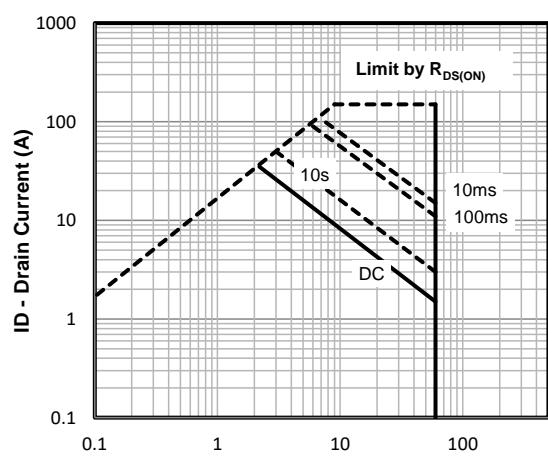


Fig5. Maximum Safe Operating Area

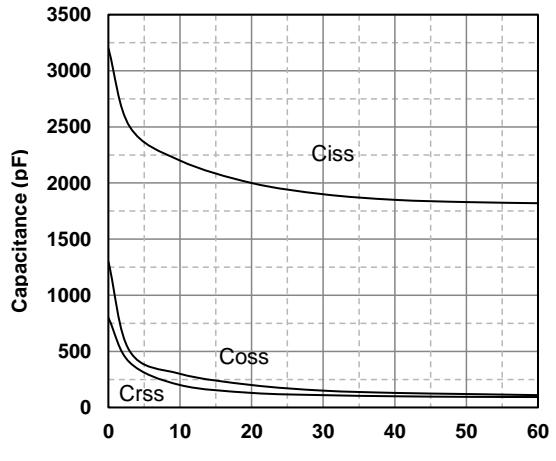
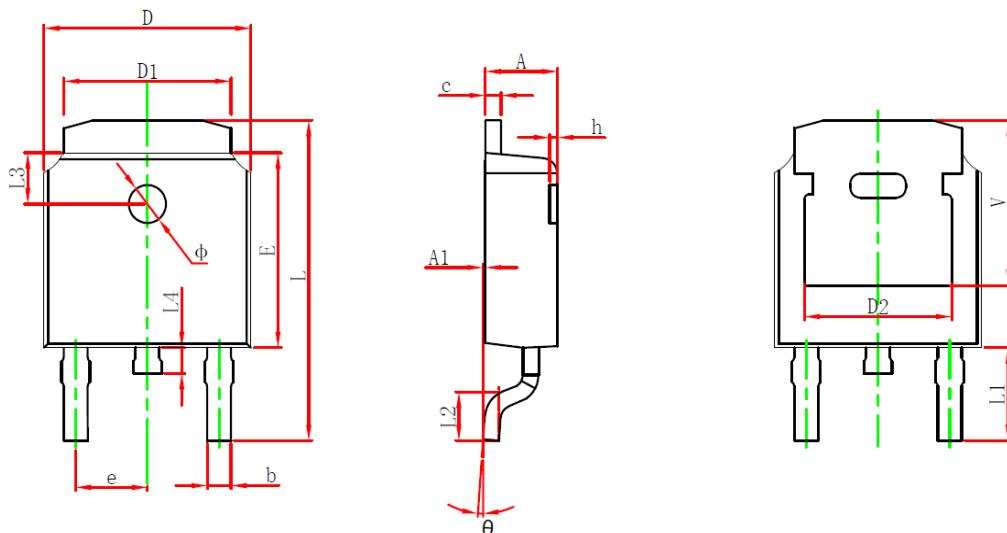


Fig6 Typical Capacitance Vs.Drain-Source Voltage

TO-252 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
c	0.450	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.712	10.312	0.386	0.406
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
Φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207 REF.	